

09/913334

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PATENT NUMBER.

U.S. UTILITY Patent Application

112 J.P.E.
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PATENT DATE

APPLICATION NO.	CONT/PRIOR	CLASS	SUBCLASS	ART UNIT	EXAMINER
09/913334	D F	438	689	2812 2922	W. F. Achong

APPlicants

Seiichi Miyazaki

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TITLE

Etchant, etching method and semiconductor silicon wafer

PTO-2040
12/99

ISSUING CLASSIFICATION

Continued on Issue Slip Inside File Jacket

TERMINAL DISCLAIMER		DRAWINGS			CLAIMS ALLOWED	
		Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
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		(Assistant Examiner) _____ (Date)				
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